

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
SI DENG	09/07/2018
YUAN GUO	09/07/2018
RECEIVING PARTY DATA	
Name:	WUHAN CHINA STAR OPTOELECTRONICS TECHNOLOGY CO., LTD.
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City:	WUHAN, HUBEI,
State/Country:	CHINA
Postal Code:	430070
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16129767
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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NAME OF SUBMITTER:	LEONG C. LEI
SIGNATURE:	/Leong C. Lei/
DATE SIGNED:	09/13/2018
	This document serves as an Oath/Declaration (37 CFR 1.63).
Total Attachments: 2	
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Combined Declaration and Assignment for Patent Application

Title of the Invention: MANUFACTURE METHOD OF LOW TEMPERATURE POLY-SILICON ARRAY SUBSTRATE

As a below named inventor, I hereby declare that:

This declaration is directed to:

- The attached application, or
[X] U.S. Application Number or PCT International Application Number 15/111,822 filed on 07/15/2016

The above-identified application was made or authorized to be made by me.

I believe I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

ASSIGNMENT

This assignment agreement is applicable to an invention entitled (Invention Title)

MANUFACTURE METHOD OF LOW TEMPERATURE POLY-SILICON ARRAY SUBSTRATE

The PATENT RIGHTS referred to in this agreement are:

(check one) [X] a patent application for this invention, executed by the ASSIGNOR(S) concurrently with this assignment.

[] U.S. patent application Serial No. filed

[] U.S. patent No. issued

The PATENT RIGHTS also include all divisions, reissues, continuations and extensions of the patents and patent applications identified above.

The PATENT RIGHTS assigned under this agreement are:

(check one) [X] U.S. patent rights only.

[] worldwide patent rights. In this case, the assignee shall have the right to claim the benefit of the filing date of any U.S. patent application identified above.

The ASSIGNOR(S) referred to in this agreement is (or are):

(check one) [X] Inventor(s)

[] Present Owner

(Full name of sole or first ASSIGNOR) Si Deng

(Address) Building C5, Biolake of Optics Valley, No. 666 Gaoxin Avenue, Wuhan East Lake High-tech Development Zone, Wuhan, Hubei, 430070, China

(Full name of second joint ASSIGNOR, if any) Yuan Guo

(Address) Building C5, Biolake of Optics Valley, No. 666 Gaoxin Avenue, Wuhan East Lake High-tech Development Zone, Wuhan, Hubei, 430070, China

(Full name of third joint ASSIGNOR, if any)

(Address)

(Full name of fourth joint ASSIGNOR, if any)

(Address)

(Full name of fifth joint ASSIGNOR, if any) _____
(Address) _____

The ASSIGNEE referred to in this agreement is:

(Name of sole or first Assignee) Wuhan China Star Optoelectronics Technology Co., Ltd.
(Address of assignee) Building C5, Biolake of Optics Valley, No. 666 Gaoxin Avenue, Wuhan East Lake High-tech
Development Zone, Wuhan, Hubei, 430070, China

The sole or first ASSIGNEE is:

(check one) An Individual.
 A Partnership.
 A Corporation of China
(state or country)

The ASSIGNOR(S), in consideration of \$1.00 paid by the ASSIGNEE, and other good and valuable consideration, receipt of which is acknowledged, have and do hereby assign the following to the ASSIGNEE; its successors and assigns:

the full and exclusive right to the invention;
the entire right, title and interest in and to the PATENT RIGHTS; and
the right to claim priority under 35 USC 119, based on any earlier foreign applications for this invention.

As to all U.S. patent applications assigned under this agreement, the ASSIGNOR(S) hereby authorize(s) and request(s) the Commissioner of Patents and Trademarks to issue all Letters Patent to the ASSIGNEE as the assignee of the entire right, title and interest, for the sole use and enjoyment of said ASSIGNEE, its successors and assigns.

Further, the ASSIGNOR(S) agree(s) to communicate to said ASSIGNEE, or its representatives, any facts known w to the ASSIGNOR(S) respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, substitute, renewal, reexamination and reissue applications, execute all necessary assignment papers to cause any and all Letter Patent to be issued to said ASSIGNEE, make all rightful oaths and generally do everything necessary or desirable to aid said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention.

ASSIGNOR(S) authorize(s) LEONG C. LEI (Reg. No. 50402) to insert or complete any information in this document needed to effect its recordal in the U.S. Patent and Trademark Office.

<u>Si Deng</u>	_____	<u>2018.9.7</u>	_____
Si Deng	(Signature of sole or first ASSIGNOR)	(Date)	
<u>Yuan Guo</u>	_____	<u>2018.9.7</u>	_____
Yuan Guo	(Signature of second joint ASSIGNOR)	(Date)	
_____	_____	_____	_____
	(Signature of third joint ASSIGNOR)	(Date)	
_____	_____	_____	_____
	(Signature of forth joint ASSIGNOR)	(Date)	
_____	_____	_____	_____
	(Signature of fifth joint ASSIGNOR)	(Date)	